



<p>1. Insulator material: N=PA6T L=LCP P=PA9T Circuits:2-40 PIN</p> <p>2. Tail Style: R0=Right angle Color: BK=Black</p> <p>3. Contact Plated: T=Matte Tin over Nickel W=Matte Tin over nickel 150μ" Y=Bright Tin over Nickel F=Gold Flash, Matte Tin 100μ" A=Gold 3μ" B=Gold 3μ" C = ordinary gold plating D=Gold 5μ"</p> <p>4. Contact Plated: I=Gold 1μ" E=Gold 5μ" G=Gold 10μ" J=Gold 10μ" L=Gold 15μ" M=Gold 15μ" V=Gold 30μ"</p> <p>5. Contact Plated: I=Gold 1μ" E=Gold 5μ" G=Gold 10μ" J=Gold 10μ" L=Gold 15μ" M=Gold 15μ" V=Gold 30μ"</p> <p>6.Special Options</p> <p>7. Packing: A=Bag B=Tube D=Small box E=Cap+Reel</p>	<p>H2 X 40 - 2 XX R0 BK X 000 X</p> <p>1 2 3 4 5 6 7</p>	<p>Recommended P.C. Board SMD Layout</p>	<p>Dim.A 4.00</p> <p>Dim.B 2.80</p>	<p>Current Rating: 2 Amps</p> <p>Insulator Resistance: 1000 Megohms min</p> <p>Dielectric Withstanding: AC 500V</p> <p>Contact Resistance: 20mΩ MAX</p> <p>Operation Temperature: -40~+105°C</p> <p>Max processing temp: 230°C for 60seconds</p> <p>Max processing temp: 260°C for 10seconds</p> <p>Contact Material: Brass</p> <p>Insulator material: Standard: Polyester,UL 94V-0</p> <p>Standard: PA6T</p> <p>Finish: Tin Gold Plated</p> <p>Standard: Gold Flash all over</p>	<p>1 2 3 4 5 6 7 8</p>
<p>1. H2N40-240BKHC4</p> <p>2. SQ0.5-9.2/13.2-X-C12</p> <p>3.</p>	<p>PART NO. H2X40-2XXR0BKX000X</p> <p>DRAWING NO. ZS-10103-P</p> <p>DRAWN BY Deng jin quan</p> <p>APPROVAL BY Chen xiao guang</p>	<p>X ±0.30</p> <p>.XX ±0.20</p> <p>.XXX ±0.1</p> <p>ITEM: H2</p> <p>SCALE:1:1</p> <p>UNIT:M:M</p>	<p>东莞市震升电子有限公司</p> <p>DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD</p> <p>TEL:0769-85305015 FAX:0769-85845060</p>	<p>EDITION:A1</p> <p>2021-12-25</p> <p>2021-12-27</p>	<p>1 2 3 4 5 6 7 8</p>